









可靠性试验

Reliability Test Items And Conditions

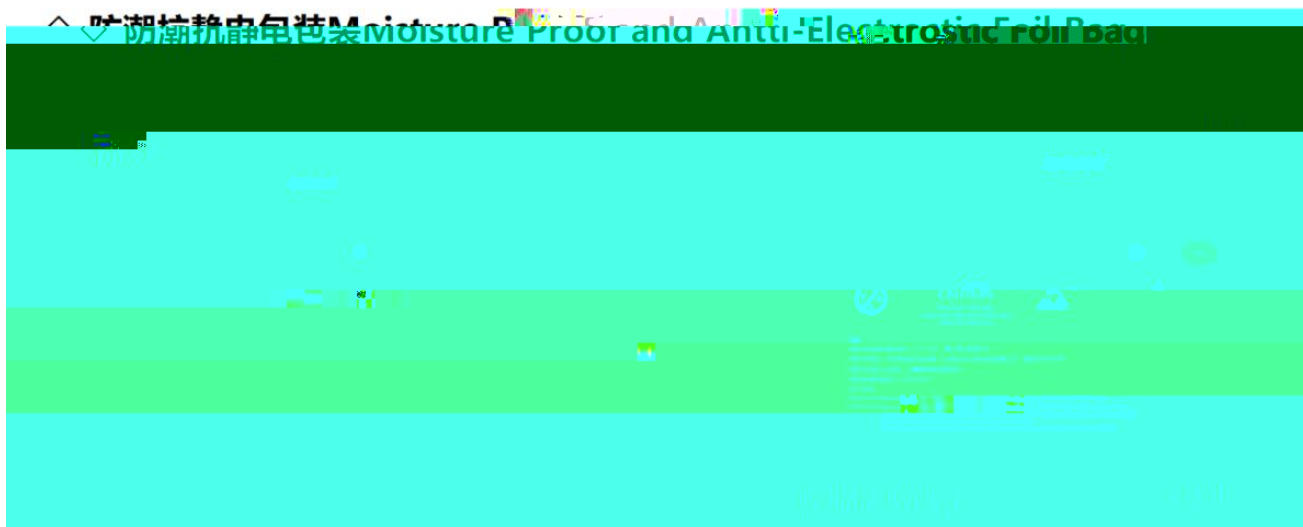
Test		Testing environment	Testing time	Reference standard
Class	item			

Part No. :XL-1606SYGO

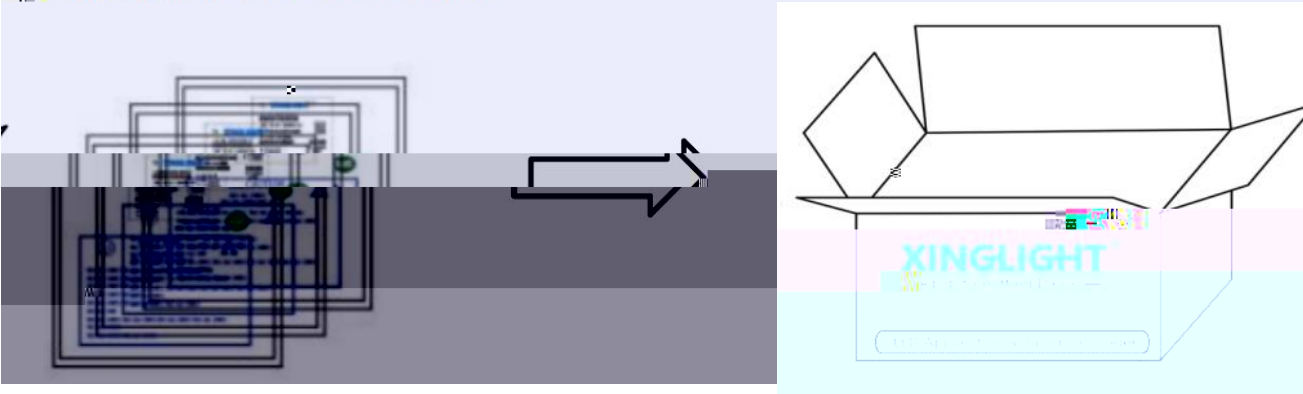


包装 (2)

Packaging (2)



外包装箱 Carton Board Box



标签说明 Label Expansion

XINGLIGHT®		XINGLIGHT®	
XINGLIGHT®		XINGLIGHT®	
WL: 波长代码	IV: 亮度代码	LOT:C250714-0402YG	QTY:4000
ORIGIN: 产地	QTY: 数量	Package:CHIP LED	
PACKAQE: 封装		Origin:CN	WL: HYG04 IV: D1 VF: M18-2

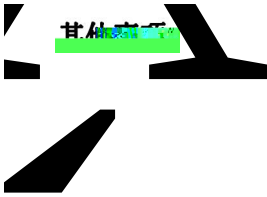




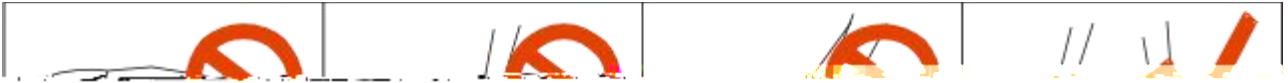


使用注意事项（3）

Precautions (3)



When handling the product, touching the encapsulant with bare hands will not only contaminate its surface, but also affect on its optical characteristics. Excessive force to the encapsulant might result in catastrophic failure of the LEDs due to die breakage or wire deformation. For this reason, please do not put excessive stress on LEDs, especially when the LEDs are heated such as during Reflow Soldering.



LED

Figure 14: LED failure modes